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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-35°C TO +85 °C(NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO +60°C(NOTE 3)
	OPERATING HUMIDITY RANGE	20 % TO 80 % (NOTE 2)	STORAGE HUMIDITY RANGE	40 % TO 70 %(NOTE 3)
	VOLTAGE	150 V AC（DC）	APPLICABLE CONNECTOR	DF14-2628SCFA DF14-3032SCFA
	CURRENT	1 A	APPLICABLE CONTACT	DF14-*S-1.25C

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	20 mV MAX, 1 mA (DC or 1000 Hz). △1	30 mΩ MAX.	X	—
INSULATION RESISTANCE	100V DC.	500 MΩ MIN.	X	—
VOLTAGE PROOF	500 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	50 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
SHOCK	490 m/s^2 DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	—
ENVIRONMENTAL CHARACTERISTICS				
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35 °C TIME 30→ 10 TO 15→ 30→ 10 TO 15 min. UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	—
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.		X	—
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING ≪REFLOW AREA≫ MAX250℃ WITHIN 10 sec MIN 230℃ WITHIN 60 sec ≪PREHEATING AREA≫ 170℃ to 190℃ 60 sec to 120 sec PUT THROUGH IN REFLOW FUMACE TWICE LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :350±5℃, SOLDERING TIME : 5±1sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 235±5°C FOR INSERTION DURATION, 3sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	—

REMARKS
NOTE1: INCLUDE THE TEMPERATURE RISING BY CURRENT
NOTE2: NO CONDENSING
NOTE3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE MOUNTED ON PCB.
AFTER MOUNTED ON PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION.

	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
△1	1	DIS-H-00004206	HK.HAYASHI	SZ.ONO	18.09.12

Unless otherwise specified, refer to IEC 60512.

APPROVED	HS.OKAWA	18.04.03
CHECKED	TS.FUKUSHIMA	18.04.03
DESIGNED	TS.KUMAZAWA	18.04.03
DRAWN	MK.INOUE	18.04.02

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

DRAWING NO. ELC-160307-54-00

HRS	SPECIFICATION SHEET	PART NO.	DF14-*P-1.25H(54)	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL538- △1	1/1

FORM HD0011-2-1